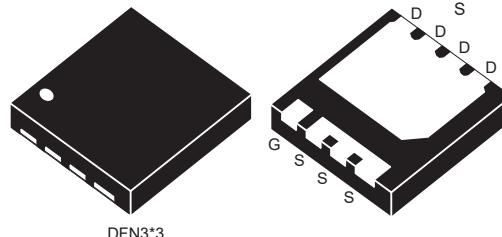
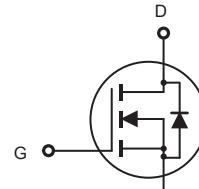


N-Channel Enhancement Mode Field Effect Transistor

FEATURES

- 40V, 72A, $R_{DS(ON)} = 3 \text{ m}\Omega$ @ $V_{GS} = 10\text{V}$.
 $R_{DS(ON)} = 4 \text{ m}\Omega$ @ $V_{GS} = 4.5\text{V}$.
- Super High dense cell design for extremely low $R_{DS(ON)}$.
- High power and current handing capability.
- Pb-free lead plating ; RoHS compliant.
- Halogen Free.



ABSOLUTE MAXIMUM RATINGS $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Limit	Units
Drain-Source Voltage	V_{DS}	40	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous	$I_D @ R_{DS(on)}$	72	A
	$I_D @ R_{DS(on)}$	23	A
Drain Current-Pulsed ^a	$I_{DM} @ R_{DS(on)}$	288	A
	$I_{DM} @ R_{DS(on)}$	92	A
Maximum Power Dissipation	P_D	25	W
Operating and Store Temperature Range	T_J, T_{stg}	-55 to 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Limit	Units
Thermal Resistance, Junction-to-Case	R_{JJC}	5	$^\circ\text{C/W}$
Thermal Resistance, Junction-to-Ambient	R_{JJA}	50	$^\circ\text{C/W}$



CEC2R04

Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Units
Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0\text{V}, I_D = 250\mu\text{A}$	40			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 40\text{V}, V_{\text{GS}} = 0\text{V}$		1		μA
Gate Body Leakage Current, Forward	I_{GSSF}	$V_{\text{GS}} = 20\text{V}, V_{\text{DS}} = 0\text{V}$		100		nA
Gate Body Leakage Current, Reverse	I_{GSSR}	$V_{\text{GS}} = -20\text{V}, V_{\text{DS}} = 0\text{V}$		-100		nA
On Characteristics^b						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{GS}} = V_{\text{DS}}, I_D = 250\mu\text{A}$	1		3	V
Static Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10\text{V}, I_D = 10\text{A}$		2.5	3	$\text{m}\Omega$
		$V_{\text{GS}} = 4.5\text{V}, I_D = 5\text{A}$		3.1	4	$\text{m}\Omega$
Gate input resistance	R_g	f=1MHz,open Drain		1.6		Ω
Dynamic Characteristics^c						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 15\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$		3085		pF
Output Capacitance	C_{oss}			765		pF
Reverse Transfer Capacitance	C_{rss}			35		pF
Switching Characteristics^c						
Turn-On Delay Time	$t_{\text{d(on)}}$	$V_{\text{DD}} = 15\text{V}, I_D = 1\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 6\Omega$		29		ns
Turn-On Rise Time	t_r			5		ns
Turn-Off Delay Time	$t_{\text{d(off)}}$			67		ns
Turn-Off Fall Time	t_f			19		ns
Total Gate Charge	Q_g	$V_{\text{DS}} = 15\text{V}, I_D = 16\text{A}, V_{\text{GS}} = 4.5\text{V}$		17		nC
Gate-Source Charge	Q_{gs}			6		nC
Gate-Drain Charge	Q_{gd}			9		nC
Drain-Source Diode Characteristics and Maximum Ratings						
Drain-Source Diode Forward Current	I_S				20	A
Drain-Source Diode Forward Voltage ^b	V_{SD}	$V_{\text{GS}} = 0\text{V}, I_S = 10\text{A}$			1.2	V

Notes :

- a.Repetitive Rating : Pulse width limited by maximum junction temperature
- b.Pulse Test : Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$.
- c.Guaranteed by design, not subject to production testing.

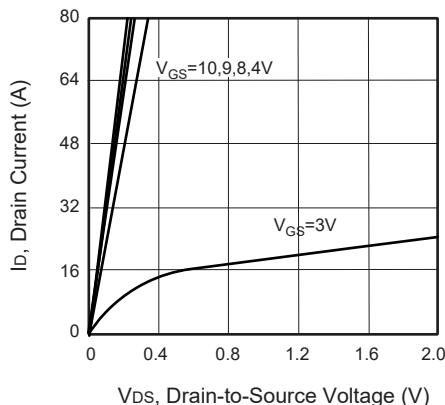


Figure 1. Output Characteristics

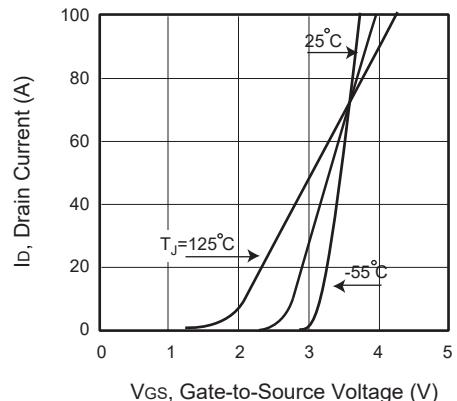


Figure 2. Transfer Characteristics

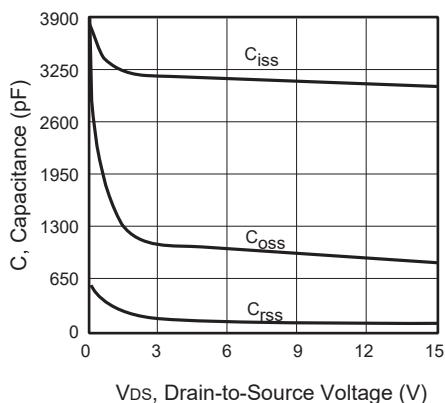


Figure 3. Capacitance

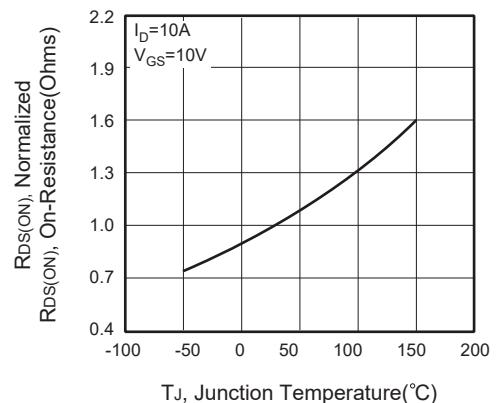


Figure 4. On-Resistance Variation with Temperature

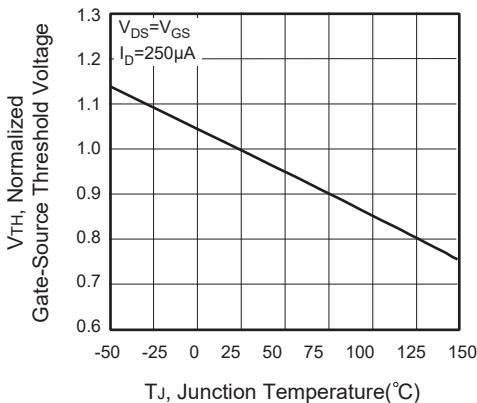


Figure 5. Gate Threshold Variation with Temperature

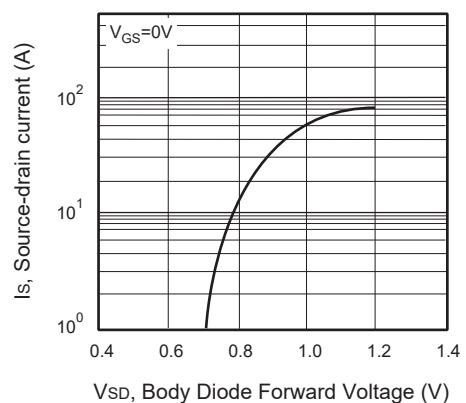
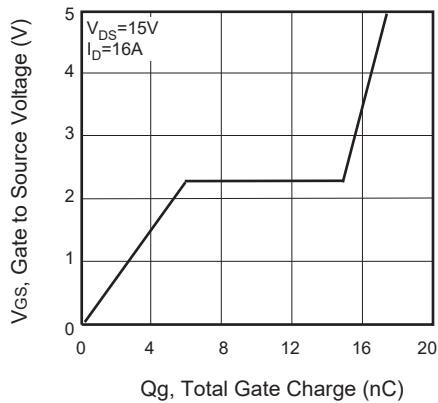
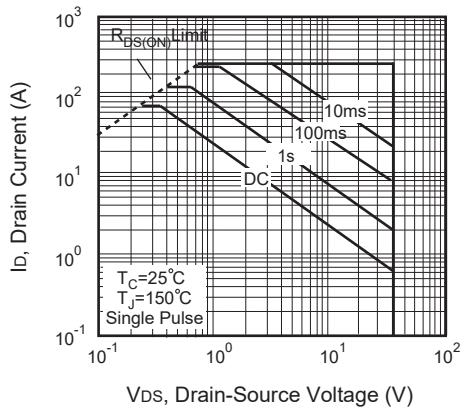
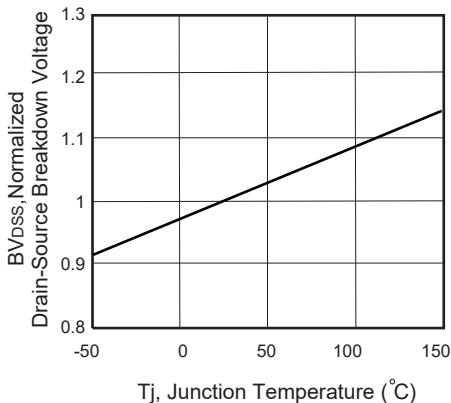
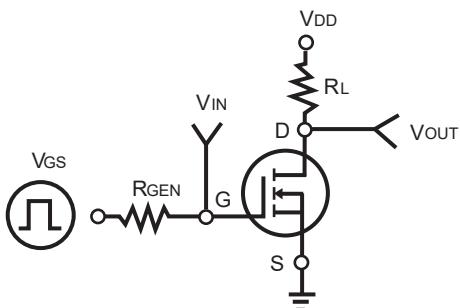
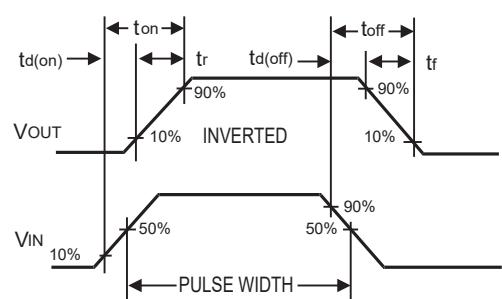


Figure 6. Body Diode Forward Voltage Variation with Source Current

**Figure 7. Gate Charge****Figure 8. Maximum Safe Operating Area****Figure 9. Breakdown Voltage Variation VS Temperature****Figure 10. Switching Test Circuit****Figure 11. Switching Waveforms**

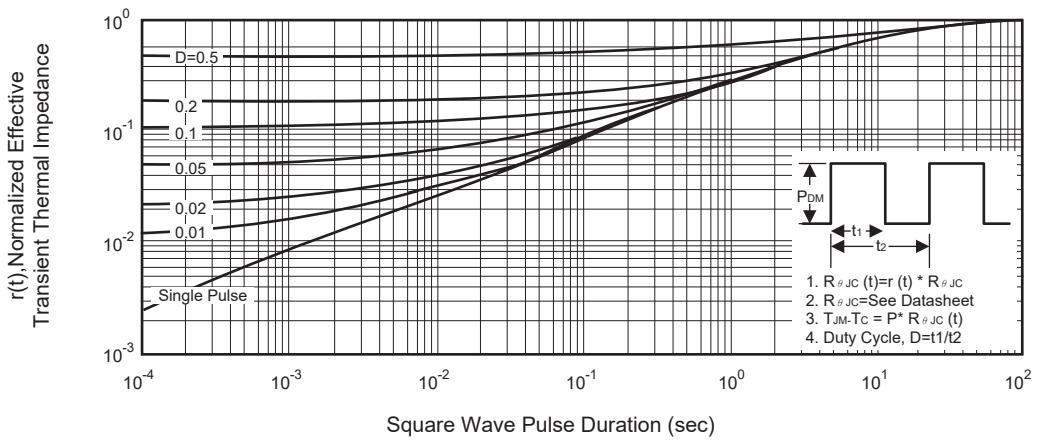
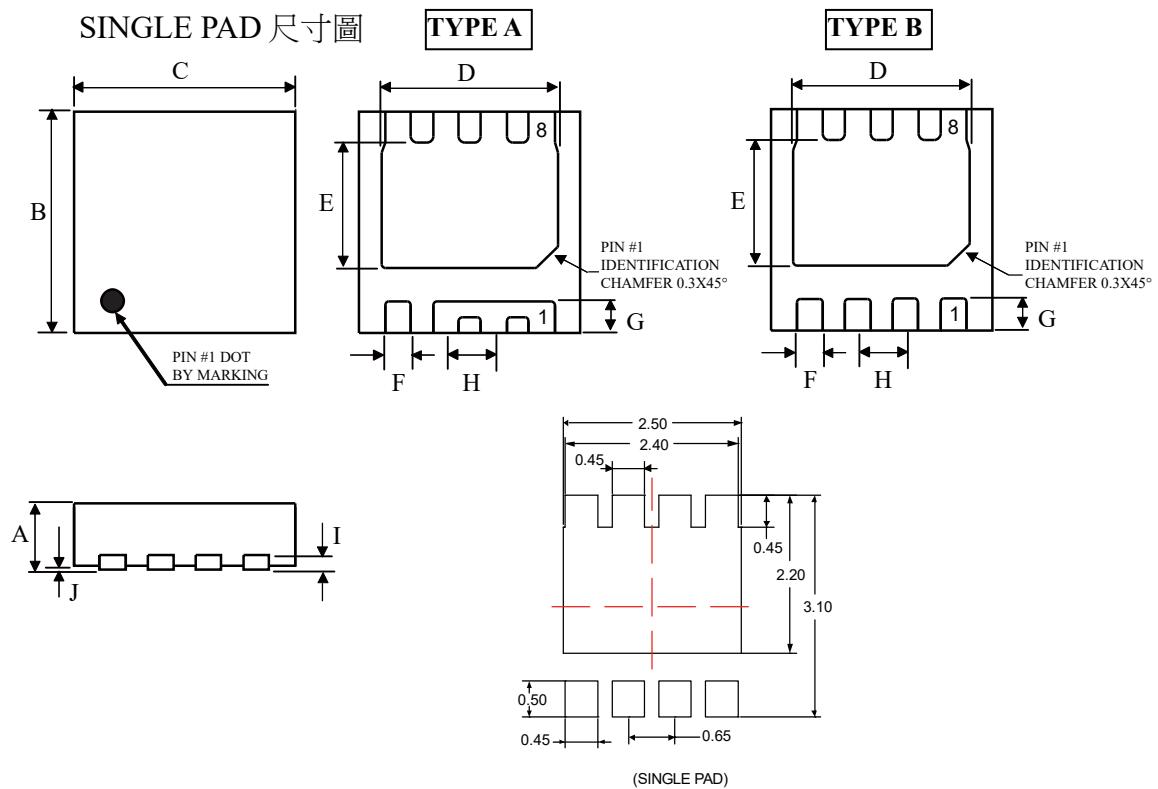


Figure 12. Normalized Thermal Transient Impedance Curve

DFN 3X3 產品外觀尺寸圖 (Product Outline Dimension)



SYMBOLS	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	0.70	0.85	0.028	0.033
B	2.90	3.10	0.114	0.122
C	2.90	3.10	0.114	0.122
D	2.35	2.49	0.093	0.098
E	1.65	1.75	0.065	0.069
F	0.30	0.40	0.012	0.016
G	0.35	0.48	0.014	0.019
H	0.65(BSC)		0.026(BSC)	
I	0.203(REF)		0.008(REF)	
J	0	0.05	0	0.002